

top hat
SURFACE MOUNT
RF Transformer

TCML1-19X+

50Ω 800 to 1900 MHz

FEATURES

- Wideband, 800 to 1900 MHz
- Balanced Transmission Line
- Plastic Base with Solder Plated Leads
- Aqueous Washable



Generic photo used for illustration purposes only

CASE STYLE: DB1627

APPLICATIONS

- Cellular
- PCN
- GPS
- Baluns
- Impedance Matching

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

ELECTRICAL SPECIFICATIONS AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Units
Impedance Ratio			1		
Frequency Range		800		1900	MHz
Insertion Loss ¹	800-1900		3		dB
	800-1400		1		

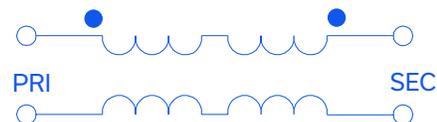
1. Insertion Loss is referenced to mid-band loss, 0.2 dB typ.

ABSOLUTE MAXIMUM RATINGS

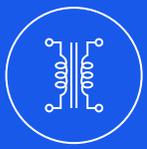
Parameter	Ratings
Operating Temperature	-20°C to +85°C
Storage Temperature	-55°C to +100°C
RF Power	0.25 W
DC Current	30 mA

Permanent damage may occur if any of these limits are exceeded.

CONFIGURATION G



REV. C
ECO-013883
TCML1-19X+
MCL NY
251124



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RF Transformer

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Mini-Circuits

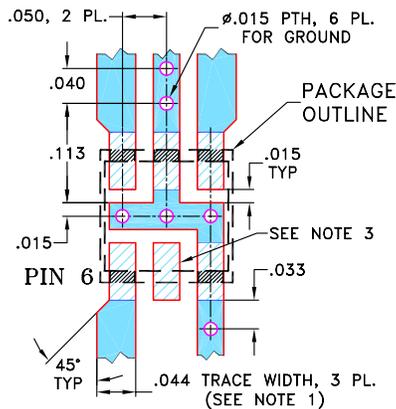
50Ω 800 to 1900 MHz

PAD CONNECTIONS

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
NOT USED	2,5

PRODUCT MARKING: AM

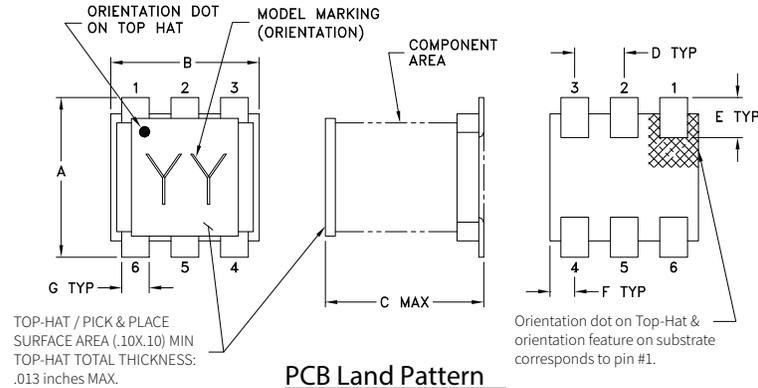
**DEMO BOARD MCL P/N: TB-TCML1-19X+
SUGGESTED PCB LAYOUT (PL-244)**



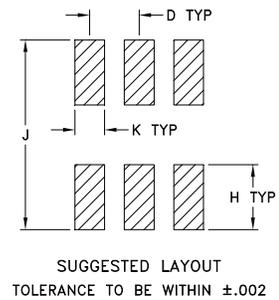
1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. ON EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
3. THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



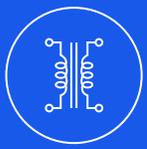
PCB Land Pattern



OUTLINE DIMENSIONS (Inches/mm)

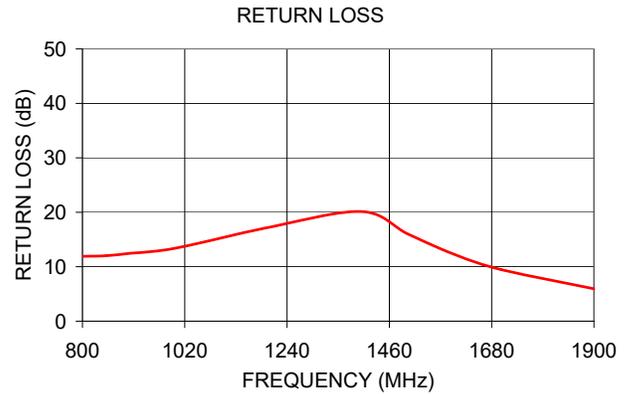
A	B	C	D	E	F
.160	.150	.160	.050	.040	.025
4.06	3.81	4.06	1.27	1.02	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.15	

TAPE & REEL INFORMATION: F47



TYPICAL PERFORMANCE DATA

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
800	0.30	11.91
850	0.59	12.02
900	0.31	12.44
1000	0.39	13.40
1200	0.14	17.22
1400	0.13	20.13
1500	0.14	16.01
1600	0.34	12.26
1700	0.55	9.49
1900	1.22	5.94



- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

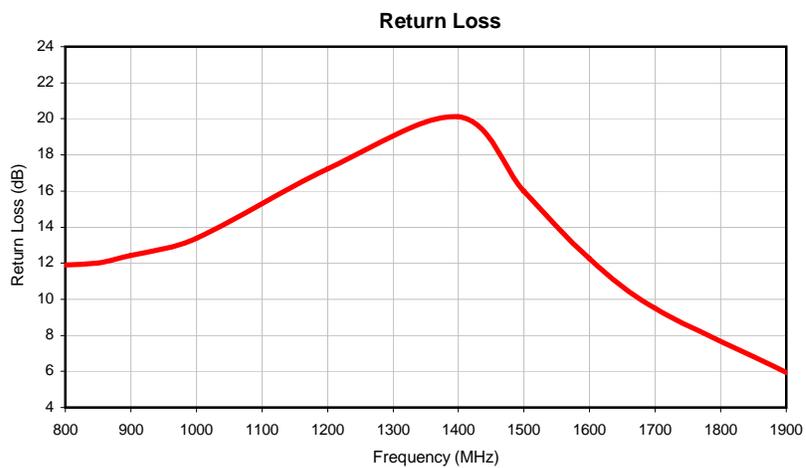
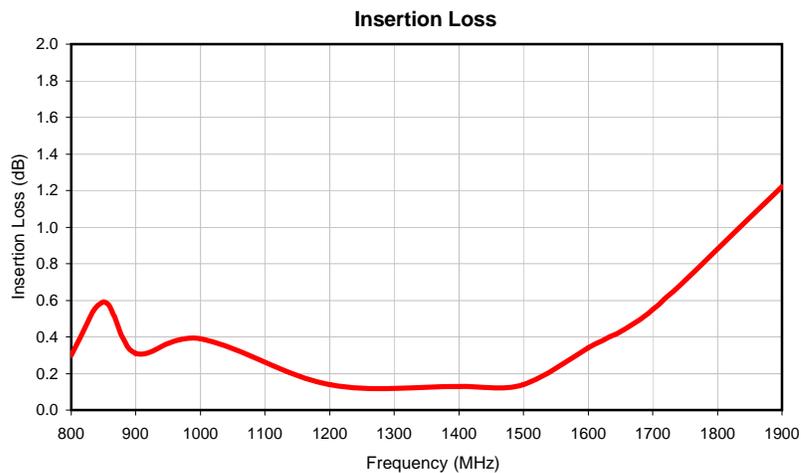
RF Transformer

TCML1-19X+

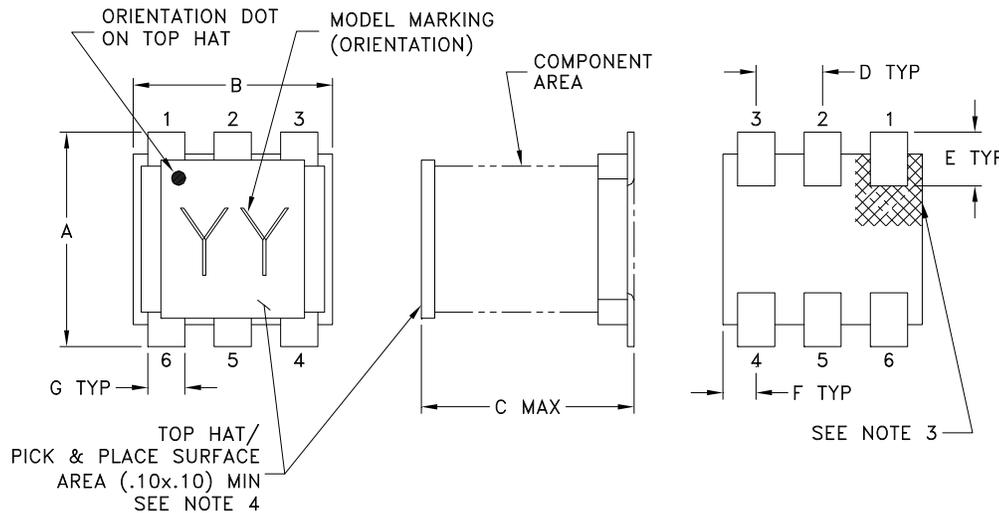
Typical Performance Data

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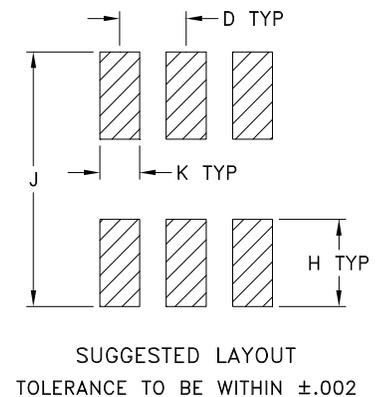
Typical Performance Data



Outline Dimensions



PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB1627	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

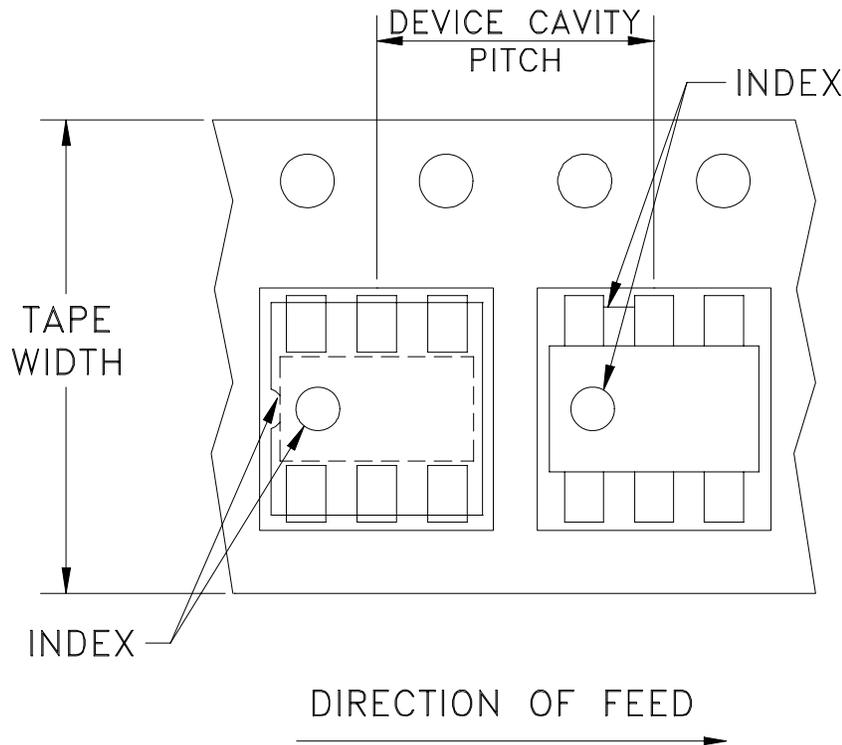
Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- Orientation dot on top hat & orientation feature on substrate correspondence to pin #1.
- Top-Hat total thickness: .013 inches MAX.

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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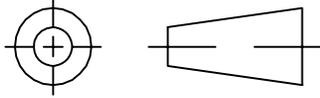
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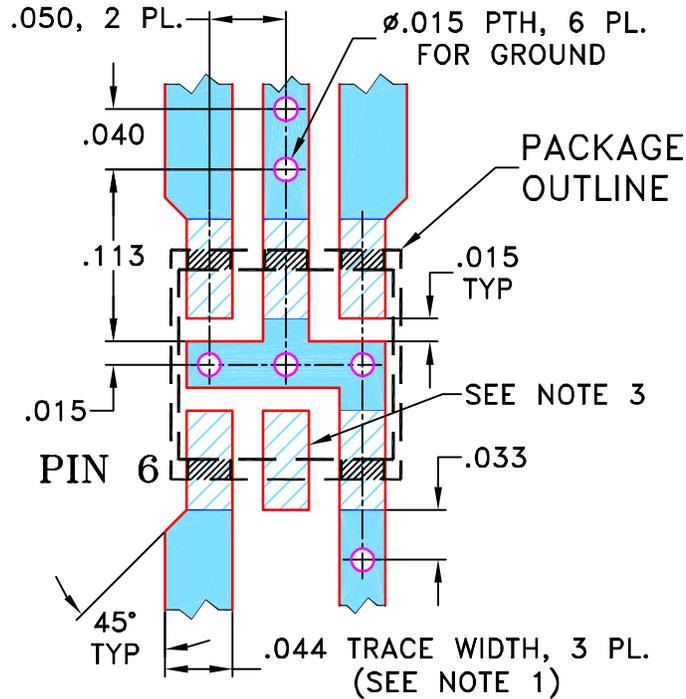
THIRD ANGLE PROJECTION



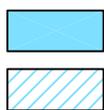
REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M106563	NEW RELEASE	08/23/06	AV	IG

SUGGESTED MOUNTING CONFIGURATION
FOR AT224/DB714 CASE STYLE, "gs/ha/hd" PIN CONNECTIONS
(FOR SINGLE ENDED TO BALANCED APPLICATION)



- NOTES:**
- TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. ON EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 - BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
 - THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

DRAWN

AV

07/28/06

TOLERANCES ON:

CHECKED

IL

08/23/06

2 PL DECIMALS ± .005

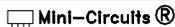
APPROVED

IG

08/23/06

ANGLES ±

FRACTIONS ±



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ASHEETA1.DWG REV:A DATE:01/12/95



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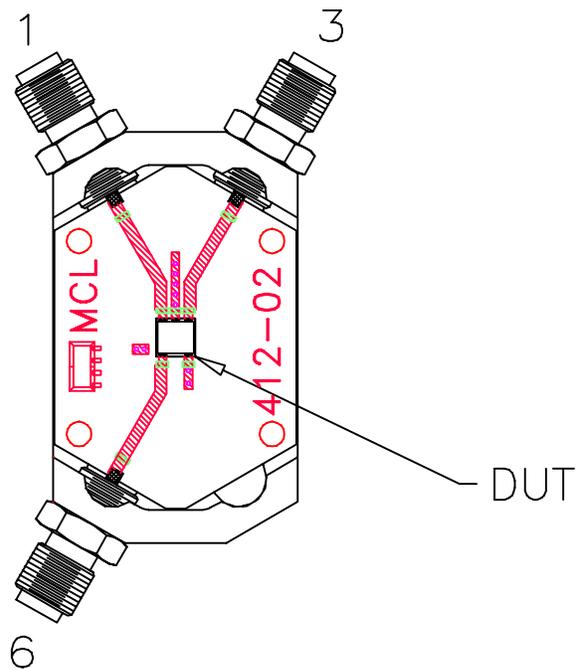
13 Neptune Avenue
 Brooklyn NY 11235

PL, gs/ha/hd, AT224/DB714, TC/TCM, TB-145

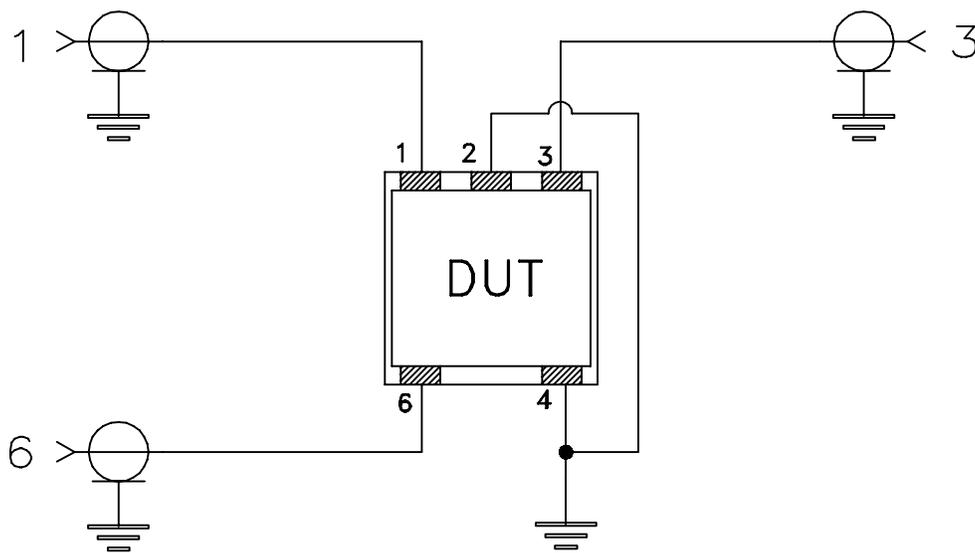
SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-244	REV: OR
FILE: 98PL244	SCALE: 8:1	SHEET: 1 OF 1	

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers RO4350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215